



Product Change Notification

112924 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

America's OEM Contact: Kevin Hinkey
Phone: (971) 712-8718 e-mail: Kevin.r.hinkey@intel.com

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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Product Change Notification

Change Notification #: 112924 - 00
Change Title: Intel® Centrino® Wireless-N 2200 SKUs:
2200BN.HMWG; 2200BN.HMWGB;
2200BNHMWDTX1; 2200BNHMWDTX1G;
2200BNHMWDTX1H
PCN 112924-00, Product Material
PCB Material Change and Label Update
Date of Publication: March 06, 2014

Key Characteristics of the Change:

Product Material, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Apr 22, 2014
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Description of Change to the Customer:

The Intel® Centrino® Wireless-N 2200 SKUs listed in this PCN will undergo the following changes:

1. The current printed circuit board FR4 material S1155 has been discontinued and will be replaced by S1150G. S1150G has passed UL certification and was determined to be equivalent to S1155. S1150G has been fully qualified and all 2014 released products were developed with S1150G. The only impact is a change to the UL Marking on some of the PCB suppliers.
2. The Intel Tracking Number on the product label for 2200BN.HMWG will change as follows:

Product Code	Old	New
2200BN.HMWG	0B	0C

Customer Impact of Change and Recommended Action:

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

For your information only. No change to form fit or function. No change to Intel Ordering codes.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
2200BN.HMW G	917565	G41460-005	G41460-006
2200BN.HMW WB	920120	G55002-002	G55002-003
2200BNHMWDTX1G	921076	G57471-004	G57471-004
2200BNHMWDTX1H	921439	G68162-003	G68162-003
2200BNHMWDTX1	921441	G60428-004	G60428-004

PCN Revision History:

Date of Revision:

March 6, 2014

Revision Number:

00

Reason:

Originally Published PCN